

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	113	(solder adj (bump, ball) with eutectic).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:08
L2	6678	(solder adj (bump, ball)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:08
L3	104269	(board, pcb).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:09
L4	1921	2 and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:09
L5	198158	(resin, epoxy).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:09
L6	546	4 and 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:10
L7	38	1 and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:10
L8	60	("4505029"   "4967950"   "4999699"   "5007163"   "5075965"   "5130779"   "5147084"   "5188280"   "5251806"   "5431328"   "5439162"   "5470787"   "5611481"   "5698465").PN. OR ("5796591").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/31 17:21